

Description

The VST25N600 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

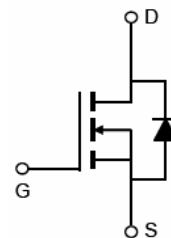
- $V_{DS} = 250V, I_D = 25A$
- $R_{DS(ON)} = 60m\Omega$ (typical) @ $V_{GS} = 10V$
- Excellent gate charge $\times R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification



TO-220C



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| VST25N600-TC | VST25N600 | TO-220C | - | - | - |

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|---------------------|------------|------|
| Drain-Source Voltage | V_{DS} | 250 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 25 | A |
| Drain Current-Continuous($T_C=100^\circ C$) | $I_D (100^\circ C)$ | 17.5 | A |
| Pulsed Drain Current | I_{DM} | 100 | A |
| Maximum Power Dissipation | P_D | 135 | W |
| Derating factor | | 0.9 | W/°C |
| Single pulse avalanche energy ^(Note 5) | E_{AS} | 320 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 175 | °C |

Thermal Characteristic

| | | | |
|--|------------------|------|------|
| Thermal Résistance, Junction-to-Case ^(Note 2) | R _{θJC} | 1.11 | °C/W |
|--|------------------|------|------|

Electrical Characteristics (T_A=25°C unless otherwise noted)

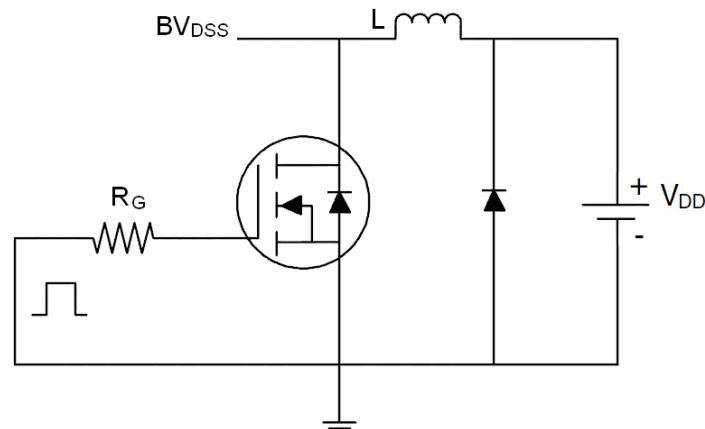
| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|---------------------|---|-----|------|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 250 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =250V, V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250μA | 2.5 | 3.5 | 4.5 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =20A | - | 60 | 70 | mΩ |
| Forward Transconductance | g _{FS} | V _{DS} =5V, I _D =20A | 15 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =125V, V _{GS} =0V, F=1.0MHz | - | 1600 | | PF |
| Output Capacitance | C _{oss} | | - | 92 | | PF |
| Reverse Transfer Capacitance | C _{rss} | | - | 4.3 | | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | t _{d(on)} | V _{DD} =125V, R _L =7.5Ω V _{GS} =10V, R _G =3Ω | - | 7 | - | nS |
| Turn-on Rise Time | t _r | | - | 9 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | | - | 25 | - | nS |
| Turn-Off Fall Time | t _f | | - | 5 | - | nS |
| Total Gate Charge | Q _g | V _{DS} =125V, I _D =20A, V _{GS} =10V | - | 24 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 9.5 | - | nC |
| Gate-Drain Charge | Q _{gd} | | - | 5.6 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V _{SD} | V _{GS} =0V, I _S =20A | - | - | 1.2 | V |
| Diode Forward Current ^(Note 2) | I _S | | - | - | 25 | A |
| Reverse Recovery Time | t _{rr} | T _J = 25°C, I _F = I _S di/dt = 100A/μs ^(Note 3) | - | 45 | - | nS |
| Reverse Recovery Charge | Q _{rr} | | - | 160 | - | nC |

Notes:

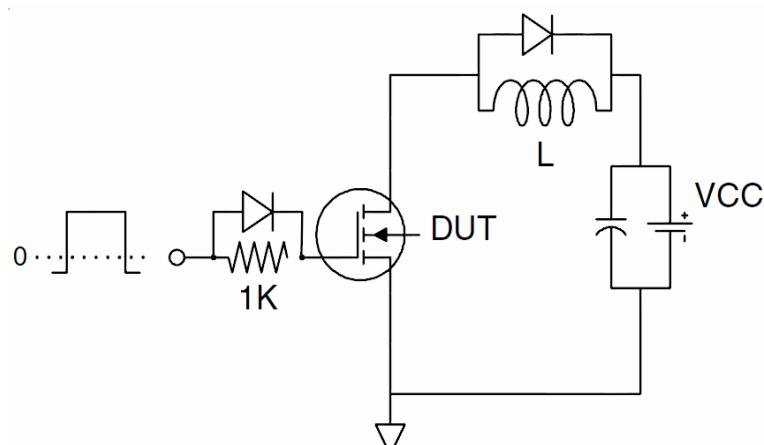
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition : T_j=25°C, V_{DD}=50V, V_G=10V, L=0.5mH, R_g=25Ω

Test Circuit

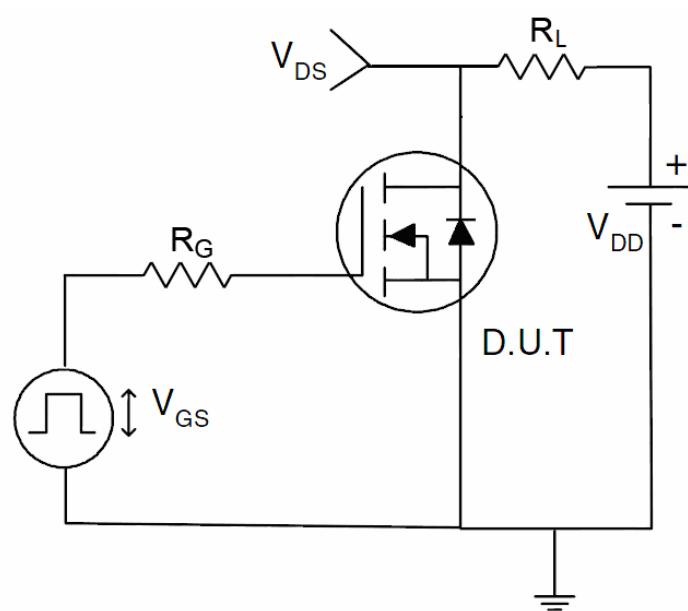
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics

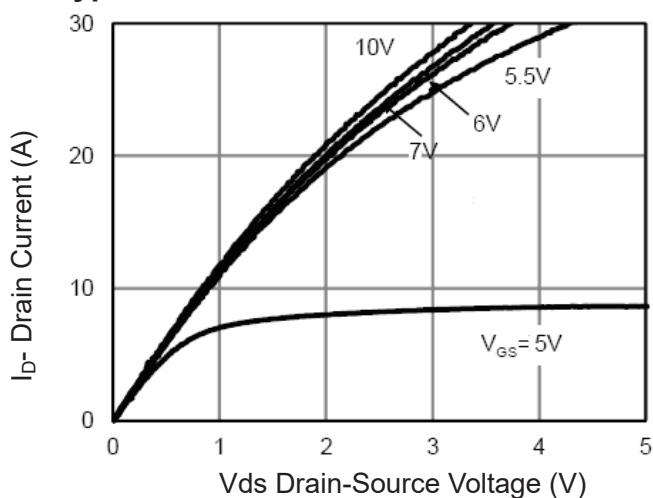


Figure 1 Output Characteristics

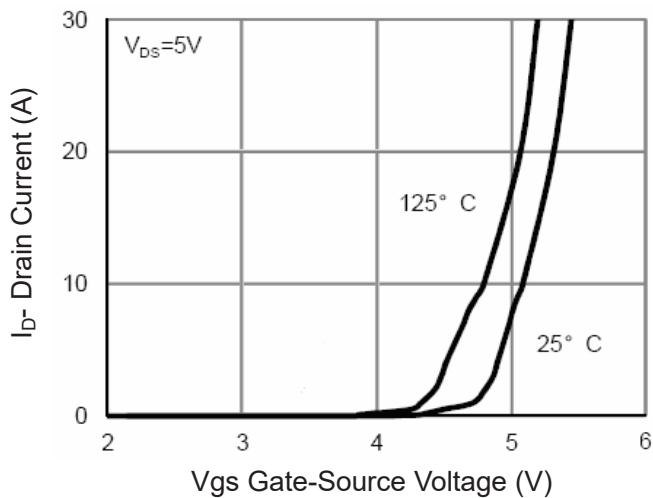


Figure 2 Transfer Characteristics

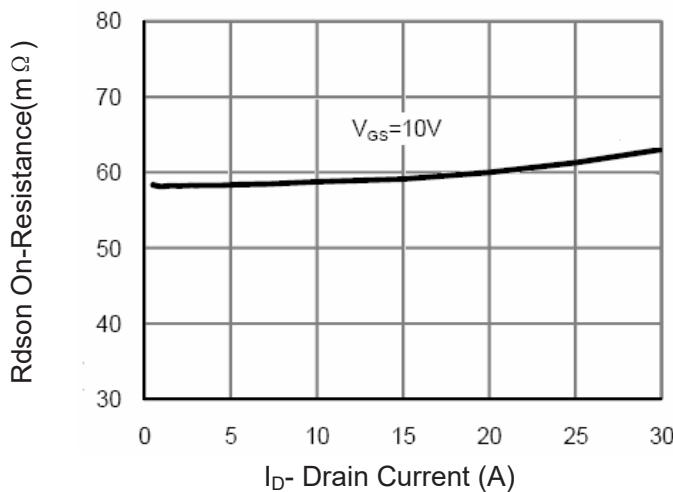


Figure 3 Rdson- Drain Current

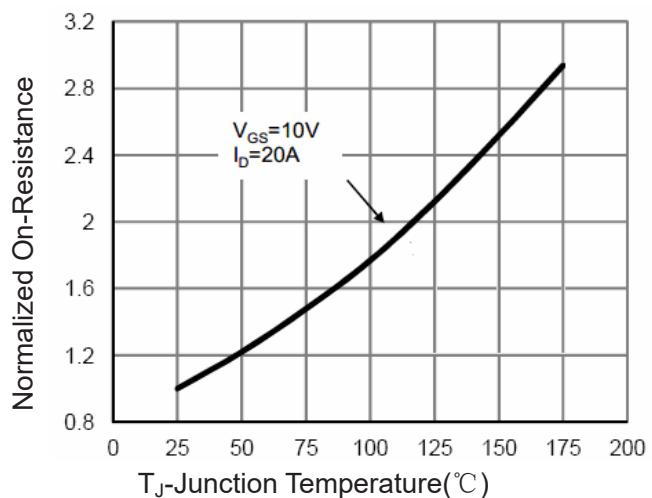


Figure 4 Rdson-Junction Temperature

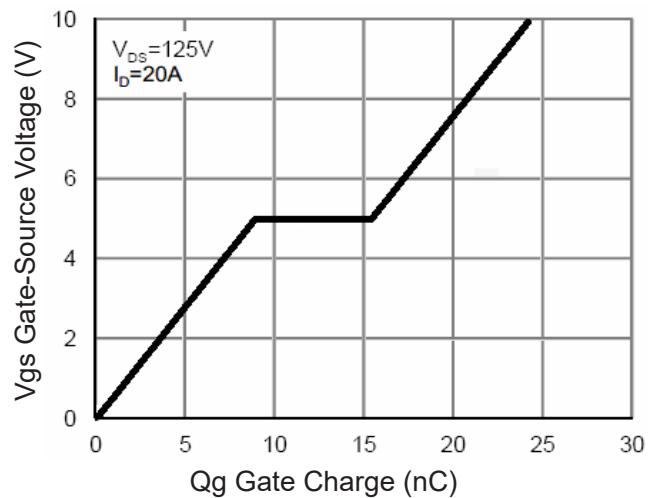


Figure 5 Gate Charge

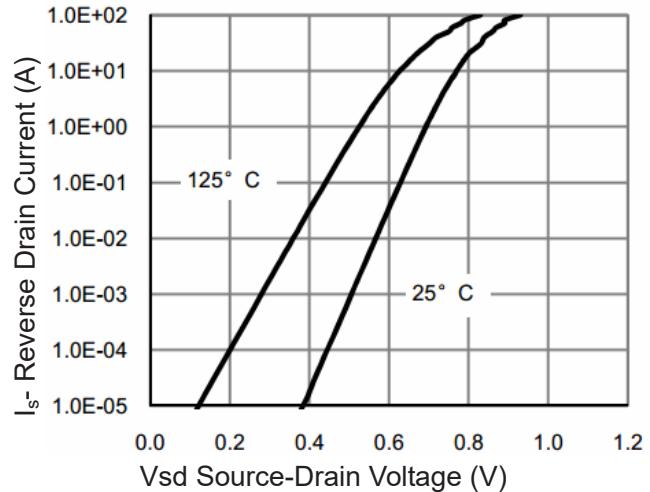
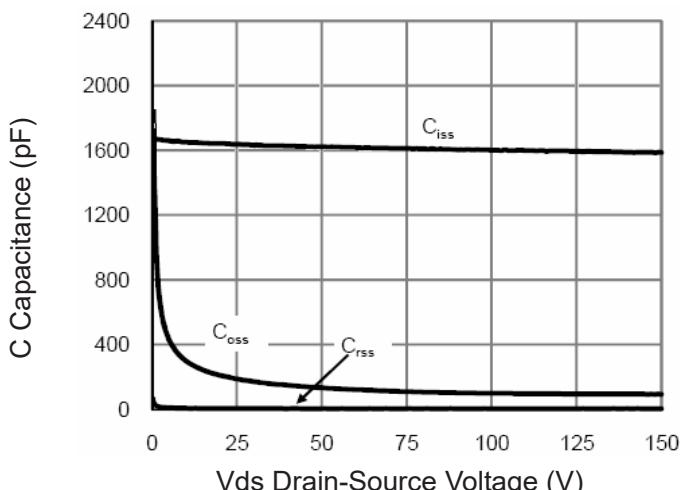
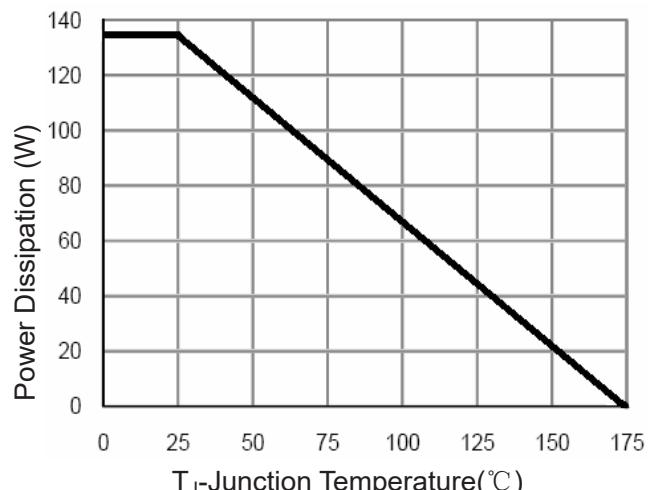
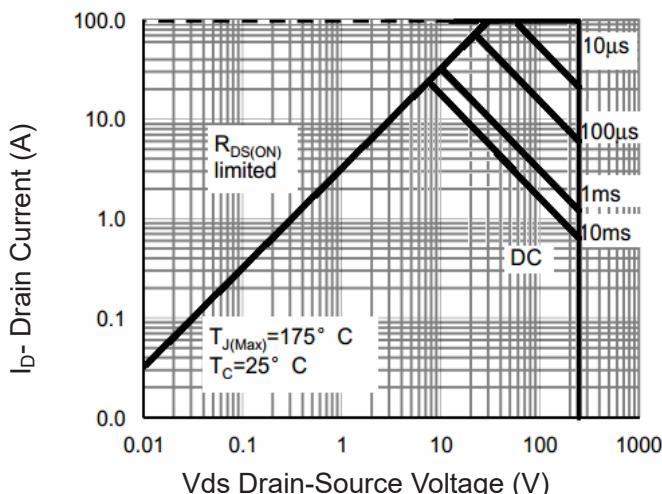
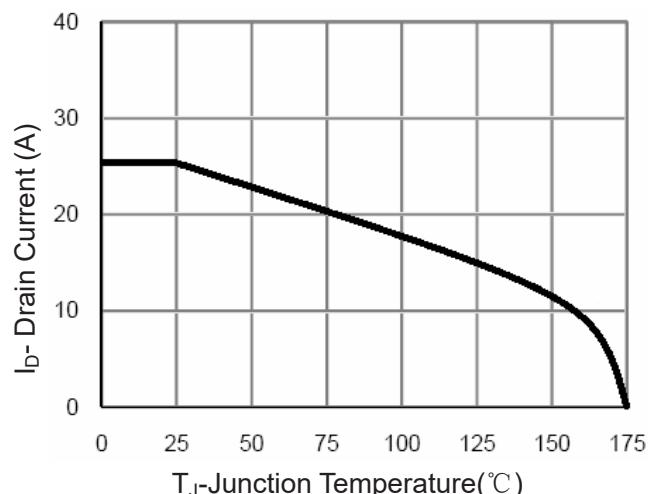
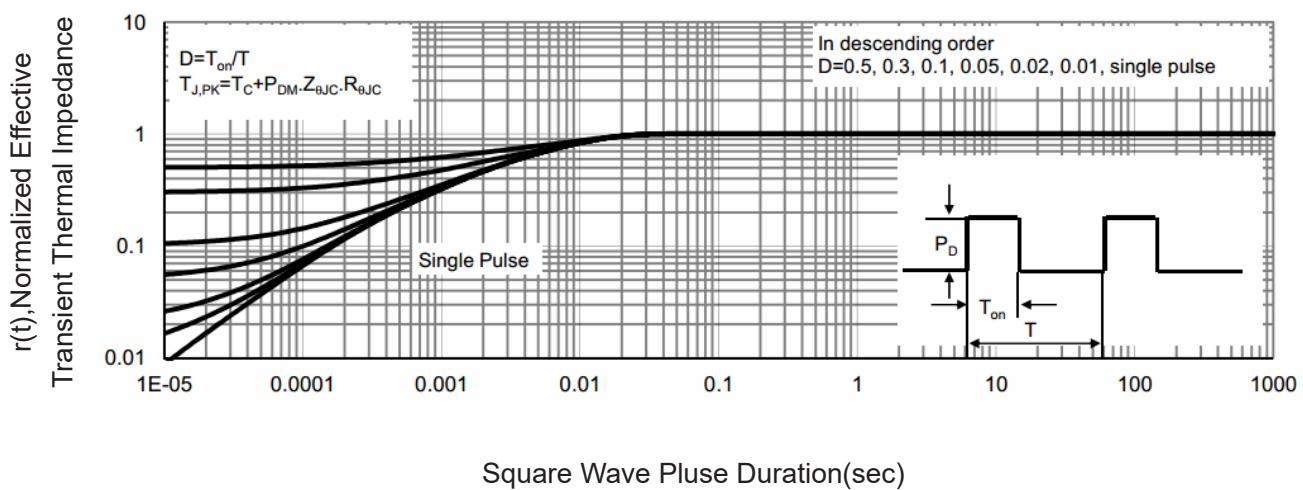


Figure 6 Source- Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating

Figure 8 Safe Operation Area

Figure 10 Current De-rating

Figure 11 Normalized Maximum Transient Thermal Impedance